

Overview

HP EliteBook 845 14 inch G10 Notebook PC



Left

- | | |
|------------------------------------|--|
| 1. Internal Microphones (2) | 8. Glass Clickpad |
| 2. Ambient Light Sensor (Optional) | 9. Smartcard Reader (Optional) |
| 3. Webcam | 10. LED Indicator |
| 4. Camera Shutter | 11. Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) ¹ |
| 5. IR Camera (Optional) | 12. Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) ¹ |
| 6. IR Camera LEDs (Optional) | 13. SuperSpeed USB Type-A 5Gbps signaling rate |
| 7. NFC Sensor | 14. HDMI 2.0 Port (Cable not included) |

1. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

Overview



Right

1. Power Button Key
2. Audio Combo Jack
3. SuperSpeed USB Type-A 5Gbps signaling rate (Charging) (USB 3.2 Gen 1)
4. Nano Security Lock Slot (Lock sold separately)
5. SIM Card Slot (Optional)
6. Touch Fingerprint Sensor (Select models)

Overview

At a Glance

- Premium ultraslim design with precision-crafted all-metal chassis for a premium look and feel
- Latest AMD® Ryzen PRO and non-PRO 7000 U and HS series processors
- Preinstalled with Windows 11 versions or FreeDOS
- New 16:10 ratio screen reduces the need to scroll by showing more vertical content than 16:9
- Optional ultrabright displays with HP Eye Ease, ambient light and ambient color sensors
- New 5MP camera⁴ with HP Auto Frame⁸ allows you around a little without losing viewers' attention during video calls
- New DDR5 5600 memory and PCI Gen4 SSDs provide fast access to your work.
- Choice of displays:
 - 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit, 250 nits, 45% NTSC
 - 35.6cm (14") diagonal WUXGA IPS Anti-Glare On-Cell LED-backlit touch, 250 nits, 45% NTSC
 - 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch 400 nits, 100% sRGB
 - 35.6cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch, 1000 nits, 100% sRGB with HP Sure View Reflect
- Redesigned keyboard layout to include easy use of discrete PgUp/Dn, End, and Home keys
- Choose from 38Whr or 51Whr battery options
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.
- Larger Clickpad surface for easier, more intuitive input
- Connectivity with optional 4G LTE WWAN available, and USB-C Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests¹
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Larger Clickpad surface for easier, more intuitive input
- Can be wiped up to 10,000 times with germicidal cleaning wipes²

1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

2. Approved germicidal wipes for use on Select HP Platforms

<https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-9819ENW>

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Technical Specifications

PRODUCT NAME

HP EliteBook 845 14 inch G10 Notebook PC

OPERATING SYSTEMS

Preinstalled

- Windows 11 Pro ¹
- Windows 11 Pro Education ¹
- Windows 11 Home - HP recommends Windows 11 Pro for Business¹
- Windows 11 Home Single Language – HP recommends Windows 11 Pro for Business ¹
- Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing Agreement) ¹
- Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) ^{1,2}
- FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

| Processor ^{3,4,5,6} | Cores | Threads | L3 Cache | Max Boost Frequency ⁵ | Base Frequency | Pro |
|------------------------------|-------|---------|----------|----------------------------------|----------------|-----|
| AMD Ryzen™ 9 PRO 7940HS | 8 | 16 | 16MB | 5.20 GHz | 4.00 GHz | X |
| AMD Ryzen™ 7 PRO 7840HS | 8 | 16 | 16MB | 5.10 GHz | 3.80 GHz | X |
| AMD Ryzen™ 7 PRO 7840U | 8 | 16 | 16MB | 5.10 GHz | 3.30 GHz | X |
| AMD Ryzen™ 5 PRO 7540U | 6 | 12 | 16MB | 4.90 GHz | 3.50 GHz | X |
| AMD Ryzen™ 7-7840U | 8 | 16 | 16MB | 5.10 GHz | 3.30 GHz | |
| AMD Ryzen™ 5-7540U | 6 | 12 | 16MB | 4.90 GHz | 3.50 GHz | |

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Max Boost clock frequency performance varies depending on hardware, software and overall system configuration.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>

Technical Specifications

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon™ Graphics⁷

Supports

Support HW decode, DX12, HDMI 2.0, HDCP 2.3

[7. HD content required to view HD images.](#)

DISPLAY

Non-Touch

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA eDP1.2, micro-edge, 250 nits, 45% NTSC, Narrow Bezel (1920 x 1200)^{7,8}

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP camera for WWAN (1920 x 1200) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera for WWAN (1920 x 1200) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera (1920 x 1200) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP camera (1920 x 1200) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for WWAN (1920 x 1200) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA eDP1.2, micro-edge, no-mic, 250 nits, 45% NTSC, Narrow Bezel (1920 x 1200) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor for 5MP Camera (1920 x 1200) with HP Eye Ease ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor for 5MP+IR Camera (1920 x 1200) with HP Eye Ease ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor for 5MP+IR Camera for WWAN (1920 x 1200) with HP Eye Ease ^{7,8}

35.6 cm (14") diagonal, WQXGA, anti-glare UWVA, eDP 1.4+PSR, micro-edge, 500 nits, Narrow Bezel for 5MP Webcam + IR camera (2560 x 1600) ^{7,8}

35.6 cm (14") diagonal, WQXGA, anti-glare UWVA, eDP 1.4+PSR, micro-edge, 500 nits, Narrow Bezel for 5MP Webcam + IR camera for WWAN (2560 x 1600) ^{7,8}

35.6 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor for 5MP camera (1920 x 1200) with HP Eye Ease ^{7,8,9,10}

35.6 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP1.3+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor for 5MP+IR camera (1920 x 1200) with HP Eye Ease ^{7,8,9,10}

Touch

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera Touch on Panel (1920 x 1200)^{7,8,10}

Technical Specifications

35.6 cm (14") diagonal WUXGA Bent, anti-glare UWVA, 250 nits, 45% NTSC for 5MP+IR camera for WWAN Touch on Panel (1920 x 1200) ^{7,8,10}

DisplayPort™ 1.2

Support HW decode, DX12, HDMI 2.0, HDCP 2.3 via HDMI/DP up to 4K@60Hz

Displays support

Supports 4 independent displays through the dock.

Display Size (Diagonal)

14"

35.6 cm (14")

7. HD content required to view HD images.

8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

9. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

10. Actual brightness will be lower with touchscreen or Sure View.

DOCKING (Sold Separately)

| | |
|---------------------------------|------------------------------|
| Docking station model #1 | HP Thunderbolt 120W G4 Dock |
| Docking station model #2 | HP Thunderbolt 280W G4 Dock |
| Docking station model #3 | HP USB-C Dock G5 |
| Docking station model #4 | HP USB-C/A Universal Dock G2 |
| Docking station model #5 | HP USB-C G5 Essential Dock |

For additional aftermarket options and docking specs please see page 40.

STORAGE AND DRIVES

Primary M.2 Storage

1 TB PCIe® 2280 OPAL2 NVME TLC SSD ¹¹

1 TB PCIe® Gen4x4 NVMe™ M.2 SSD TLC ^{11,52}

2 TB PCIe® 2280 NVMe™ TLC SSD ¹¹

512 GB PCIe® 2280 OPAL2 NVME TLC SSD ¹¹

512 GB PCIe® NVMe™ Value SSD ¹¹

512 GB PCIe® NVMe™ TLC SSD ¹¹

256 GB PCIe® 2280 OPAL2 NVMe Val SSD

256 GB PCIe® NVMe™ Value SSD ¹¹

11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

52. Available only to HK (Hong Kong), TW (Taiwan) and CN (China).

Technical Specifications

MEMORY

Maximum Memory

64GB DDR5-5600 (2 x 32 GB) ¹²

Memory

64GB DDR5-5600 (2 x 32 GB) ¹²

32GB DDR5-5600 (2 x 16 GB) ¹²

32GB DDR55600 (1 x 32 GB) ¹²

16GB DDR5-5600 (2 x 8 GB) ¹²

16GB DDR55600 (1 x 16 GB) ¹²

8GB DDR55600 (1 x 8 GB) ¹²

Memory Slots¹³

2 SODIMM

Supports Dual Channel Memory

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

13. All slots are non-accessible / non-upgradeable.

NETWORKING/COMMUNICATIONS

WLAN

Mediatek RZ616 Wi-Fi 6E Bluetooth® 5.3 AIM-T WLAN Wireless Card ¹⁴

Realtek 8852CE Wi-Fi 6E + Bluetooth® 5.3 M.2 2230 PCI-e+ USB WLAN Wireless Card ¹⁴

WWAN

Intel® XMM 7560 R+ LTE-Advanced Pro WWA ¹⁵

Intel® 5000 5G Solution WWAN ^{15,16}

NFC

NFC Mirage WNC XRAV-1

Miracast

Native Miracast Support ¹⁷

14. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

15. WWAN module is optional, must be configured at the factory, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

16. Intel® 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100MHz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards

Technical Specifications

compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

17. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen

2 Integrated stereo speakers

Integrated dual array microphone

Speaker Power

2W/4ohm Per speaker

Camera

Dual Array Digital Microphone 5MP USB2 Narrow Field of View Integrated Camera

Dual Array Digital Microphone 5MP USB2 Infrared Narrow Field of View Integrated Camera

5 MP + IR camera for face authentication with Windows Hello

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant with optional Backlit keyboard ¹⁸

Pointing Device

Clickpad with multi-touch gesture support, taps enabled as default

Microsoft Precision Touchpad Default Gestures Support

Function Keys

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center (Programmable Key)

Print Screen

Power Button (with LED)

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

Technical Specifications

18. Backlit keyboard is an optional feature.

SOFTWARE AND SECURITY

Preinstalled Software

Software

HP Easy Clean ¹⁹

HP PC Hardware Diagnostics Windows

myHP

HP Smart Support ²⁰

HP Services Scan ²¹

HP Connection Optimizer

HP Hotkey Support

HP Support Assistant ²²

HP Notifications

HP Privacy Settings

HP Power Manager²³

Microsoft Office sold separately and requires Internet access for activation.

Manageability Features

HP Connect ²⁴

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download) ²⁵

HP Client Management Script Library (download)

HP Patch Assistant (download) ²⁶

HP Driver Packs (download)

HP Client Catalog (download)

HP Cloud Recovery ²⁷

Security Management

HP Wolf Security for Business ²⁸ includes:

HP Sure Click ²⁹

HP Sure Sense ³⁰

HP Sure Run ³¹

HP Sure Recover ³²

HP Sure Start ³³

HP Tamper Lock ³⁴

HP Sure Admin ³⁵

BIOS

HP BIOSphere Gen6 ³⁶

HP Secure Erase ³⁷

Absolute Persistence Module ³⁸

BIOS Update via Network

HP Wake on WLAN

Secured-Core PC Enable ³⁹

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

HP Fingerprint Sensor ⁴⁰

Technical Specifications

Security

TPM

Model: Nuvoton NPCT760HABYX

Version: 7.2.3.1

Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

Smartcard Reader

Model number: Alcor AU9560

FIPS 201 Compliant: Yes

IPv6 Support

Yes

FirstNet Certified

Yes

The BIOS on this notebook implements ISO/IEC 19678:2015 guidelines (formerly NIST 800-147).

UEFI version: 2.7

Class: 3

19. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions

20. HP Smart Support requires HP TechPulse to be installed. For more information about how to enable or to download HP Smart Support, please visit <http://www.hp.com/smart-support>.

21. HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP TechPulse follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access with connection to TechPulse portal is required. For full system requirements or to disable this feature, please visit <http://www.hpdaas.com/requirements>. Not applicable in China.

22. HP Support Assistance requires Windows and Internet Access

23. HP Power Manager requires Windows 10 and higher and can be downloaded from the Microsoft Store.

24. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

25. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>.

26. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>.

27. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Details please refer to: <https://support.hp.com/us-en/document/c05115630>.

28. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

29. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

Technical Specifications

30. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS
 31. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.
 32. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module
 33. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher
 34. HP Tamper Lock must be enabled by the customer or your administrator
 35. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from <http://www.hp.com/go/clientmanagement> and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store
 36. HP BIOSphere Gen6 features may vary depending on the platform and configuration.
 37. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
 38. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: <https://www.absolute.com/about/legal/agreements/absolute/>
 39. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.
 40. HP Fingerprint sensor is an optional feature that must be configured at purchase.
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Technical Specifications

POWER

Power Supply

HP Smart 65 W USB Type-C adapter ⁴¹

Battery

HP Long Life 3-cell, 38 Wh Polymer ^{42,43}

HP Long Life 3-cell, 51 Wh Polymer ^{42,43}

Power Cord

3-wire plug - 1m ⁴¹

2-wire plug - 1m⁴¹

Battery Life

Up to TBC ⁴⁴

41. Availability may vary by country.

42. Battery is internal and not replaceable by customer. Serviceable by warranty.

43. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

44. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight ⁴⁵

Starting at 3.05 lb

Starting at 1.38 kg

Product Dimensions (W x D x H)

12.42 x 8.82 x 0.76 in

31.56 x 22.4 x 1.92 cm

Packaging Dimensions (W x D x H) ⁴⁶

12"-15" boxes (305mm height): 1200mm x 1000mm x 1080mm

45. Weight will vary by configuration. Does not include power adapter.

46. Product packaging size varies based on options chosen. Please contact your HP representative for your packaging size details.

Technical Specifications

PORTS/SLOTS

- 2 Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) ⁴⁷
- 2 Super Speed USB Type-A 5Gbps signaling rate (1 charging)
- 1 HDMI 2.0 ⁴⁸
- 1 Headphone/microphone combo jack

47. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

48. HDMI cable sold separately.

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.⁴⁹

49. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <http://www.hp.com/go/cpc>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Technical Specifications

SYSTEM UNIT

| | |
|--|---|
| Stand-Alone Power Requirements (AC Power) | Type-C Adapter |
| Nominal Operating Voltage | AC 20V |
| Average Operating Power | |
| Integrated graphics | Yes |
| Discrete Graphics | N/A |
| Max Operating Power | 65W |
| Temperature | |
| Operating | 32° to 95° F (0° to 35° C) (No sustained direct exposure to sunlight) (System performance may be reduced above 32°C (89.6°F)) |
| Non-operating | -4° to 140° F (-20° to 60° C) |
| Relative Humidity | |
| Operating | 10% to 90% (non-condensing) |
| Non-operating | 5% to 95% (38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing) |
| Shock | |
| Operating | 40 G, 2 ms, half-sine |
| Non-operating | 200 G, 2 ms, half-sine |
| Random Vibration | |
| Operating | 1.043 grams |
| Non-operating | 3.5 grams |
| Altitude (unpressurized) | |
| Operating | 10,000 ft (3,048 m) |
| Non-operating | 40,000 ft (12,192 m) |
| Planned Industry Standard Certifications | |
| Regulatory Model Number | HSN-I49C-4 |
| CSA/UL 62368-1 | Yes |
| ENERGY STAR® | Yes ⁵⁰ |
| EPEAT® | EPEAT® Gold in the United States ⁵¹ |
| FCC/ICES/CISPR/VCCI | Yes |
| CE MARKING | Yes |
| GS Mark | Yes |
| | Related commodity should comply with ISO 9241 Standards. |
| China CCC/SRRC | Yes |
| Taiwan BSMI/NCC | Yes |
| Korea KCC/KC/KES | Yes |
| Ukraine NSoC/TEC | Yes |
| EAEU Compliance | Yes |
| Saudi Arabian Compliance | Yes |
| TCO | Yes |
| Low Blue Light | Yes |
| WW RoHS | Yes |

Technical Specifications

50. Configurations of the HP EliteBook 845 14 inch G10 Notebook PC that are ENERGY STAR® qualified are identified as HP EliteBook 845 14 inch G10 Notebook PC cording to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit <http://www.epeat.net> for more information.

51. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit <http://www.epeat.net> for more information.

DISPLAYS

1. Actual brightness will be lower with touchscreen or HP Sure View.

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

| | | |
|--|---------------------------------------|-------------------------|
| 14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 eDP 1.2 w/o PSR 45 bent LCD Panel | Outline Dimensions (W x H x D) | 301.590 x 188.500 (typ) |
| | Active Area | 307.590 x 199.550 (max) |
| | Weight | 300 (max) |
| | Diagonal Size | 14 |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 1000:1(typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 250 nits ¹ |
| | Pixel Resolution - Format | 1920 x 1200 (WUXGA) |
| | Backlight | WLED |
| | Pixel Resolution | RGB |
| | Color Gamut Coverage | NTSC 45% |
| | Color Depth | 8 |
| Viewing Angle | UWVA 89/89/89/89 | |
| Low Blue Light | No | |
| Power Consumption (W, EBL@ 150nits max/ 200nits max) | 2.20 (max) / 2.70 (max) | |

| | | |
|--|---------------------------------------|-------------------------|
| 14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 TOP eDP 1.2 w/o PSR 45 bent LCD Panel | Outline Dimensions (W x H x D) | 301.590 x 188.500 (typ) |
| | Active Area | 307.590 x 199.550 (max) |
| | Weight | 300 (max) |
| | Diagonal Size | 14 |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | Yes ¹ |
| | Contrast Ratio | 1000:1(typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 250 nits ¹ |
| | Pixel Resolution - Format | 1920 x 1200 (WUXGA) |

Technical Specifications

| | |
|---|-------------------------|
| Backlight | WLED |
| Pixel Resolution | RGB |
| Color Gamut Coverage | NTSC 45% |
| Color Depth | 8 |
| Viewing Angle | UWVA 89/89/89/89 |
| Low Blue Light | No |
| Power Consumption (W, EBL@ 150nits max/ 200nits max) | 2.10 (max) / 2.60 (max) |

| | | |
|---|---------------------------------------|-------------------------|
| 14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel | Outline Dimensions (W x H x D) | 301.590 x 188.500 (typ) |
| | Active Area | 307.590 x 199.550 (max) |
| | Weight | 210 (max) |
| | Diagonal Size | 14 |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 1000:1(typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 400 nits ¹ |
| | Pixel Resolution - Format | 1920 x 1200 (WUXGA) |
| | Backlight | WLED |
| | Pixel Resolution | RGB |
| | Color Gamut Coverage | sRGB 100% |
| | Color Depth | 8 |
| | Viewing Angle | UWVA 89/89/89/89 |
| | Low Blue Light | Yes |
| Power Consumption (W, EBL@ 150nits max/ 200nits max) | 1.29 (max) / 1.66 (max) | |

| | | |
|--|---------------------------------------|-------------------------|
| 14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel | Outline Dimensions (W x H x D) | 301.680 x 188.500 (typ) |
| | Active Area | 307.600 x 199.550 (max) |
| | Weight | 238 (max) |
| | Diagonal Size | 14 |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 1500:1 (typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 1000 nits ¹ |
| | Pixel Resolution - Format | 1920 x1200 (WUXGA) |
| | Backlight | WLED |

Technical Specifications

| | |
|---|------------------|
| Pixel Resolution | RGB |
| Color Gamut Coverage | sRGB 100% |
| Color Depth | 8 |
| Viewing Angle | UWVA 85/85/85/85 |
| Low Blue Light | Yes |
| Power Consumption (W, EBL@ 150nits max/ 200nits max) | N/A |

| | | |
|--|---|-------------------------|
| 14.0 in WQXGA DRM (2560 x 1600) Anti-Glare UWVA LED DCI-P3 NB2X 500 eDP 1.4+PSR2 100 120Hz bent LCD Panel | Outline Dimensions (W x H x D) | 301.594 x 188.496 (typ) |
| | Active Area | 307.594 x 199.546 (max) |
| | Weight | 230 (max) |
| | Diagonal Size | 14 |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 1200:1(typ) |
| | Refresh Rate | 120 Hz |
| | Brightness | 500 nits ¹ |
| | Pixel Resolution - Format | 2560 x1600 (WQXGA) |
| | Backlight | WLED |
| | Pixel Resolution | RGB |
| | Color Gamut Coverage | DCI-P3 100% |
| | Color Depth | 8 |
| | Viewing Angle | UWVA 89/89/89/89 |
| | Low Blue Light | No |
| | Power Consumption (W, EBL@ 150nits max/ 200nits max) | 2.88 (max) / 3.44 (max) |

Technical Specifications

STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

| | | |
|--|---------------------------------|------------------------|
| SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell¹ | Form Factor | M.2 2280 |
| | Capacity | 1TB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 3200 MB/s ± 10% |
| | Minimum Sequential Write | 2700 MB/s ± 10% |
| | Logical Blocks | 2,000,409,264 |
| | Features | Pyrite 2.0; TRIM; L1.2 |

1. Available only to HK (Hong Kong), TW (Taiwan) and CN (China).

| | | |
|--|---------------------------------|------------------------|
| SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell | Form Factor | M.2 2280 |
| | Capacity | 2TB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 6400 MB/s ± 10% |
| | Minimum Sequential Write | 5000 MB/s ± 10% |
| | Logical Blocks | 4,000,797,360 |
| | Features | Pyrite 2.0; TRIM; L1.2 |

| | | |
|--|---------------------------------|--------------------------|
| 256GB PCIe 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive | Form Factor | M.2 2280 |
| | Capacity | 256GB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 2000 MB/s ± 10% |
| | Minimum Sequential Write | 900 MB/s ± 10% |
| | Logical Blocks | 500,118,192 |
| | Features | TCG Opal 2.0; TRIM; L1.2 |

| | | |
|---|---------------------------------|--------------------------|
| 512GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive | Form Factor | M.2 2280 |
| | Capacity | 512GB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 6400 MB/s ± 10% |
| | Minimum Sequential Write | 3500 MB/s ± 10% |
| | Logical Blocks | 1,000,215,215 |
| | Features | TCG Opal 2.0; TRIM; L1.2 |

Technical Specifications

| | | |
|---|---------------------------------|--------------------------|
| 1TB PCIe-4x4 2280 NVMe Self Encrypted OPAL2 Three Layer Cell Solid State Drive | Capacity | 1TB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 6400 MB/s \pm 10% |
| | Minimum Sequential Write | 5000 MB/s \pm 10% |
| | Logical Blocks | 2,000,409,264 |
| | Features | TCG Opal 2.0; TRIM; L1.2 |

| | | |
|---|---------------------------------|---------------------|
| SSD 256GB 2280 PCIe NVMe Value | Form Factor | M.2 2280 |
| | Capacity | 256 GB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 2000 MB/s \pm 10% |
| | Minimum Sequential Write | 900 MB/s \pm 10% |
| | Logical Blocks | 500,118,192 |
| Features | Pyrite 2.0; TRIM; L1.2 | |

| | | |
|---|---------------------------------|---------------------|
| SSD 512GB 2280 PCIe NVMe Value | Form Factor | M.2 2280 |
| | Capacity | 512 GB |
| | NAND Type | TLC |
| | Interface | PCIe NVMe Gen4X4 |
| | Minimum Sequential Read | 2200 MB/s \pm 10% |
| | Minimum Sequential Write | 1000 MB/s \pm 10% |
| | Logical Blocks | 1,000,215,215 |
| Features | Pyrite 2.0; TRIM; L1.2 | |

Technical Specifications

NETWORKING/COMMUNICATIONS

| | | |
|--|------------------------------------|---|
| Realtek RTL8852CE 802.11ax 2x2 Wi-Fi 6E + Bluetooth® 5.3 Wireless Card¹ (802.11ax 2x2, supporting gigabit data rate) | Wireless LAN Standards | <ul style="list-style-type: none"> IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k |
| | Interoperability | Wi-Fi certified |
| | Frequency Band | <ul style="list-style-type: none"> •802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz |
| | Data Rates | <ul style="list-style-type: none"> • 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz) |
| | Modulation | Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM |
| | Security² | <ul style="list-style-type: none"> • IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 (personal) certification • IEEE 802.11i • WAPI • EAP |
| | Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| | Roaming | IEEE 802.11 compliant roaming between access points |
| | Output Power³ | <ul style="list-style-type: none"> • 802.11b : +17dBm minimum • 802.11g : +16dBm minimum • 802.11a : +17dBm minimum • 802.11n HT20(2.4GHz) : +14dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +14dBm minimum • 802.11n HT40(5GHz) : +13dBm minimum |

Technical Specifications

| | |
|---|---|
| | <ul style="list-style-type: none"> • 802.11ac VHT80(5GHz) : +10dBm minimum • 802.11ac VHT160(5GHz) : +10dBm minimum • 802.11ax HE40(2.4GHz) : +12dBm minimum • 802.11ax HE80(5GHz) : +10dBm minimum • 802.11ax HE160(5GHz) : +10dBm minimum • 802.11ax HE80(6GHz) : +10dBm minimum • 802.11ax HE160(6GHz) : +10dBm minimum |
| Power Consumption | <ul style="list-style-type: none"> • Transmit mode :2.5 W • Receive mode :2 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode :50 mW (WLAN unassociated) • Connected Standby/Modern Standby: 10mW • Radio disabled: 8 mW |
| Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode |
| Receiver Sensitivity⁴ | <ul style="list-style-type: none"> •802.11b, 1Mbps : -93.5dBm maximum •802.11b, 11Mbps : -84dBm maximum •802.11a/g, 6Mbps : -86dBm maximum •802.11a/g, 54Mbps : -72dBm maximum •802.11n, MCS07 : -67dBm maximum •802.11n, MCS15 : -64dBm maximum •802.11ac, MCS0(VHT80) : -84dBm maximum •802.11ac, MCS9(VHT80) : -59dBm maximum •802.11ac, MCS9(VHT160) : -58.5dBm maximum •802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum •802.11ax, MCS11(HE160): -53.5dBm maximum |
| Antenna type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications |
| Form Factor | PCI-Express M.2 MiniCard |
| Dimensions | 1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm |
| Weight | 1. Type 2230 : 2.8g 2. Type 1216: 1.3g |
| Operating Voltage | 3.3v +/- 9% |
| Temperature | Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) |
| Humidity | Operating 10% to 60% (non-condensing) Non-operating 5% to 95% (non-condensing) |
| Altitude | Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m) |
| LED Activity | N/A |

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Technical Specifications

| | |
|-------------------------------------|---|
| Frequency Band | 2402 to 2480 MHz |
| Number of Available Channels | Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH) |
| Data Rates and Throughput | Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) |
| Transmit Power | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR. |
| Power Consumption | Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW |
| Bluetooth Software Supported | Microsoft Windows Bluetooth Software |
| Link Topology | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.407 |
| Power Management | ETS 300 328 Low Voltage Directive |
| Certifications | CE Mark |
| Bluetooth Profiles Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range Windows BT profiles support |

Technical Specifications

BT5.3

Periodic Advertisement interval

Encryption key size control enhancements

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
 2. Check latest software/driver release for updates on supported security features.
 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
-

Technical Specifications

| | |
|---|--|
| <p>Mediatek RZ616 Wi-Fi 6E + Bluetooth® 5.3 Wireless Card¹ (802.11ax 2x2, supporting gigabit data rate)</p> | <p>Wireless LAN Standards</p> <ul style="list-style-type: none"> IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11j IEEE 802.11k IEEE 802.11mc IEEE 802.11r IEEE 802.11v IEEE 802.11w |
| <p>Interoperability</p> | <p>Wi-Fi certified</p> |
| <p>Frequency Band</p> | <ul style="list-style-type: none"> •802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.925 – 7.125 GHz |
| <p>Data Rates</p> | <ul style="list-style-type: none"> • 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz) |
| <p>Modulation</p> | <p>Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM</p> |
| <p>Security²</p> | <ul style="list-style-type: none"> • IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 (personal) certification • IEEE 802.11i • WAPI |
| <p>Network Architecture Models</p> | <p>Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)</p> |
| <p>Roaming</p> | <p>IEEE 802.11 compliant roaming between access points</p> |
| <p>Output Power³</p> | <p>2.4GHz (MIMO, typical):</p> <ul style="list-style-type: none"> • 802.11b : +18dBm • 802.11g : +16.5dBm • 802.11n/ac/ax (HT20/VHT20/HE20) : +16dBm |

Technical Specifications

| | |
|--|---|
| | <ul style="list-style-type: none"> • 802.11n/ac/ax (HT40/VHT40/HE40) : +12.5dBm |
| | <p>5GHz (MIMO, typical):</p> <ul style="list-style-type: none"> • 802.11a : +13dBm • 802.11n/ac/ax (HT20/VHT20/HE20) : +13.5dBm • 802.11n/ac/ax (HT40/VHT40/HE40) : +12.5dBm • 802.11ac/ax (VHT80/HE80) : +11.5dBm • 802.11ax HE160 : +11.5dBm |
| | <p>6GHz LPI mode (MIMO, typical):</p> <ul style="list-style-type: none"> • 802.11a : 0dBm • 802.11ax HE20 : +1dBm • 802.11ax HE40 : +4dBm • 802.11ax HE80 : +7dBm • 802.11ax HE160 : +7.5dBm |
| Power Consumption | <ul style="list-style-type: none"> • Transmit mode :2.5 W • Receive mode :2 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode :50 mW (WLAN unassociated) • Connected Standby/Modern Standby: 10mW • Radio disabled: 8 mW |
| Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode |
| Receiver Sensitivity ⁴ | <p>2.4GHz (SISO):</p> <ul style="list-style-type: none"> •802.11b, 11Mbps : -82dBm maximum • 802.11g, 54Mbps : -71 dBm maximum • 802.11n, MCS7 : -64dBm maximum • 802.11ac, MCS9 : -52dBm maximum •802.11ax, MCS11(HT40): -49dBm maximum <p>5GHz (SISO):</p> <ul style="list-style-type: none"> • 802.11a, 54Mbps : -71 dBm maximum • 802.11n, MCS07 : -64dBm maximum • 802.11ac, MCS9 : -52dBm maximum •802.11ax, MCS11(HE80/HE160): -46dBm maximum <p>6GHz (SISO):</p> <ul style="list-style-type: none"> • 802.11a, 54Mbps : -71 dBm maximum • 802.11n, MCS7 : -64dBm maximum • 802.11ac, MCS9 : -52dBm maximum •802.11ax, MCS11(HE160): -46dBm maximum |
| Antenna type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications |
| Form Factor | PCI-Express M.2 MiniCard |
| Dimensions | <ol style="list-style-type: none"> 1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm |

Technical Specifications

| | |
|--------------------------|---|
| Weight | 1. Type 2230 : 2.8g 2. Type 1216: 1.3g |
| Operating Voltage | 3.3v +/- 9% |
| Temperature | Operating 14° to 158° F (–10° to 70° C) Non-operating –40° to 176° F (–40° to 80° C) |
| Humidity | Operating 10% to 60% (non-condensing) Non-operating 5% to 95% (non-condensing) |
| Altitude | Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m) |
| LED Activity | N/A |

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

| | |
|-------------------------------------|--|
| Bluetooth Specification | 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant |
| Frequency Band | 2402 to 2480 MHz |
| Number of Available Channels | Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH) |
| Data Rates and Throughput | Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) |
| Transmit Power | The Bluetooth component shall operate as a Class 1.5 Bluetooth device with a maximum transmit power of + 14 dBm and 10 dBm for BR and EDR, respectively. |
| Power Consumption | Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW |
| Bluetooth Software Supported | Microsoft Windows Bluetooth Software |
| Link Topology | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.407 |
| Power Management | ETS 300 328 Low Voltage Directive |
| Certifications | CE Mark |
| Bluetooth Profiles Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy |

Technical Specifications

LE Privacy 1.2 –Extended Scanner Filter Policies
LE Data Packet Length Extension
FAX Profile (FAX)
Basic Imaging Profile (BIP)2
Headset Profile (HSP)
Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)
BT5.2
ESR9/10 Compliance
LE Advertisement Extensions
Channel Selection Algo
Limited High Duty Cycle Non-Connectable Advertising
2Mbps LE
LE Long Range
Windows BT profiles support
BT5.3
Periodic Advertisement interval
Encryption key size control enhancements

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
2. Check latest software/driver release for updates on supported security features.
3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Technical Specifications

**Intel® (R) 5G Solution
5000¹**

**Technology/Operating
bands**

WCDMA/HSPA+ operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)

Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)

Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)

Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)

Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)

Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)

Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)

Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)

Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)

Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)

Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)

Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

Band 29: 717 to 728 MHz (DL)

Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

Band 32: 1452 to 1496 MHz (DL)

Band 34: 2010 to 2025 MHz (UL/DL)

Band 38: 2570 to 2620 MHz (UL/DL)

Band 39: 1880 to 1920 MHz (UL/DL)

Band 40: 2300 to 2400 MHz (UL/DL)

Band 41: 2496 to 2690 MHz (UL/DL)

Band 42: 3400 to 3600 MHz (UL/DL)

Band 43: 3400 to 3800 MHz (UL/DL)

Band 46: 5150 to 5925 MHz (DL)

Band 48: 3550 to 3700 MHz (UL/DL)

Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)

Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

5G NR Sub 6GHz

n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)

n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)

n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)

n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)

n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)

n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

n38: 2570 to 2620 MHz (UL/DL)

Technical Specifications

| | |
|--|--|
| | n40: 2300 to 2400 MHz (UL/DL) n41: 2496 to 2690 MHz (UL/DL) n48: 3550 to 3700 MHz (UL/DL) n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) n77: 3300 to 4200 MHz (UL/DL) n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL) |
| Wireless protocol standards | 5G NR Air Interface 3GPP Rel15 5G NR sub-6 LTE Rel14 20 layers and 2 Gbps downlink (DL) throughput – 4 × 4 MIMO across 5x CA 200 Mbps/uplink (UL) throughput – 40 MHz ULCA and 256 QAM WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification |
| GPS | Standalone, A-GPS (MS-A, MS-B) |
| GPS bands | GPS: L1 (1575.42MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz) |
| Maximum data rates | SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps 5G NSA sub 6G : DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL : 1.6 Gbps) ue-CategoryUL 18 , (UL: 211Mbps) DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload) |
| Maximum output power | LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm NR: 23 dBm in all band except n41, n77, n78 and n79 LTE n41, n77, n78 and n79 HPUE = 26dBm HSPA+: 23.5 dBm |
| Maximum power consumption | 5G Sub 6 : 2500 mA LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) |
| Form Factor | M.2, 3052-S3 Key B |
| Weight | 8 g |
| Dimensions (Length x Width x Thickness) | 52 mm × 30 mm × 2.3 mm |
| embedded eSIM | Support |

1. Intel® 5G module is optional and must be configured at the factory. Module designed for 5G SA (standalone), and 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100MHz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards

Technical Specifications

compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

| | | |
|--|--|---|
| Intel® XMM™ 7560 R+ LTE-Advanced Pro ¹ | Technology/Operating bands | FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz |
| | Wireless protocol standards | 3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification |
| | GPS | Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B) |
| | GPS bands | 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz |
| | Maximum data rates | LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) |
| | Maximum output power | LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm |
| | Maximum power consumption | LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) |
| | Form Factor | M.2, 3042-S3 Key B |
| | Weight | 6 g |
| | Dimensions (Length x Width x Thickness) | 42 x 30 x 2.3 mm |
| | embedded eSIM | Support |

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Technical Specifications

| | | |
|-----------------------|---|--|
| NFC NXP NPC300 | Dimensions (L x W x H) | 17 x 10 x 2.0 mm |
| | Chipset | NPC300 |
| | System interface | I2C |
| | | ISO/IEC 14443 A |
| | | ISO/IEC 14443 B |
| | | ISO/IEC 15693 |
| | | ISO/IEC 18092 |
| | | ECMA-340 NFCIP-1 Target and Initiator |
| | NFC RF standards | ECMA-320 NFCIP-2 |
| | NFC Forum Support | Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2 |
| | | ISO/IEC 14443 A |
| | | ISO/IEC 14443 B |
| | | ISO/IEC 15693 |
| | | MIFARE 1K |
| | | MIFARE 4K |
| | | MIFARE DESFire |
| | | FeliCa |
| | Reader (PCD-VCD) Mode | Jewel and Topaz cards |
| | | ISO/IEC 14443 A |
| | | ISO/IEC 14443 B and B' |
| | Card Emulation (PICC-VICC) Mode | MIFARE |
| | | FeliCa |
| | Frequency | 13.56 MHz |
| | NFC Modes Supported | Reader/Writer, Peer-to-Peer |
| | Raw RF Data Rates | 106, 212, 424, 848 kbps |
| | Operating temperature | 0°C to 70°C |
| | Storage temperature | -20°C to 125°C |
| | | 10-90% operating |
| | Humidity | 5-95% non-operating |
| | Supply Operating voltage | 4.35 to 5.25 Volts |
| | I/O Voltage | 1.8V or 3.3V |
| | Power Consumption | |
| | (Booster enable, VBAT= 3.3V, VCC_BOOST = 5V) | |
| | Mode | Power Consumption, Typical |
| | Polling | 7.3 mA |
| | | Total 283.8 mA |
| | Detected Test Tag Type 1 | Net Module 236.8 mA |
| | | Total 288.8 mA |
| | Detected Test Tag Type 2 | Net Module 241.8 mA |
| | | Total 287.7 mA |
| | Detected Test Tag Type 3 | Net Module 240.7 mA |
| | | Total 282.3 mA |
| | Detected Test Tag Type 4 | Net Module 235.3 mA |
| | Antenna | Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is external to module. |

Technical Specifications

POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

| | | |
|---|--|--|
| AC Adapter 65 Watt nPFC Standard USB Type C® Straight 1.8m | Dimensions (H x W x D) | 3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm) |
| | Weight | 0.53 lb (240 g) max (Not including power cord. Power cord varies by country.) |
| | Input | 100-240Vac |
| | Input Efficiency | Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V : 81.5% 9V : 86.7% 12V : 88.0% 15V : 89.0% 20V : 89.0% |
| | Input frequency range | 47-63Hz |
| | Input AC current | Max. 1.6 A at 90 Vac |
| Output | Output power | 5V/15W 9V/27W 12V/60W 15V/65W 20V/65W |
| | DC output | 5V/9V/12V/15V/20V |
| | Hold-up time | 100% load 5ms at 115 Vac input |
| | Output current limit | < 8.0A |
| Connector | | USB Type-C® |
| Environmental Design | Operating temperature | 32°F to 95°F (0°to 35°C) |
| | Non-operating (storage) temperature | -4°F to 185°F (-20°to 85°C) |
| | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | Humidity | 20% to 95% |
| | Storage Humidity | 10% to 95% |
| EMI and Safety Certifications | | CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC |

Technical Specifications

| | | | |
|--|---|--|--|
| HP 65W Slim USB-C Straight AC Power Adapter | Dimensions (H x W x D) | 3.819 x 2.106 x 0.827 in (9.7x5.35x2.1 cm) | |
| | Weight | 0.49 lb (220 g) max (Not including power cord. Power cord varies by country.) | |
| | Input | 100-240Vac | |
| | Output | Input Efficiency | Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V : 81.5% 9V : 86.7% 12V : 88.0% 15V : 89.0% 20V : 89.0% |
| | | Input frequency range | 47-63Hz |
| | | Input AC current | Max. 1.6 A at 90 Vac |
| | | Output power | 5V/15W 9V/27W 12V/60W 15V/65W 20V/65W |
| | | DC output | 5V/9V/12V/15V/20V |
| | | Hold-up time | 100% load 5ms at 115 Vac input |
| | Connector | Output current limit | < 8.0A |
| Environmental Design | USB TYPE C® | | |
| | Operating temperature | 32°F to 95°F (0° to 35°C) | |
| | Non-operating (storage) temperature | -4°F to 185°F (-20° to 85°C) | |
| | Altitude | 0 to 16,400 ft (0 to 5000m) | |
| | Humidity | 20% to 95% | |
| EMI and Safety Certifications | Storage Humidity | 10% to 95% | |
| | CE Mark - full compliance with LVD and EMC directives | | |
| | Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL 62368-1 | | |
| Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC | | | |

Technical Specifications

| | | |
|---|--|---|
| HP 3-cell Long Life Li-Ion (WP 38Wh)¹ | Weight | 0.184kg +/- 10g (0.406lb) |
| | Cells/Type | 3cell Lithium-Ion Polymer cell / 564975 |
| Energy | Voltage | 11.58V |
| | Amp-hour capacity | 3.283Ah |
| | Watt-hour capacity¹ | 38Wh |
| Temperature | Operating (Charging) | 32° to 113° F (0° to 45° C) |
| | Operating (Discharging) | 14° to 140° F (-10° to 60° C) |
| | Optional Travel Battery Available | No |

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

| | | |
|---|--|---|
| HP 3-cell Long Life Li-Ion (WQ 38Wh)¹ | Weight | 0.178kg +/- 10g (0.392lb) |
| | Cells/Type | 3cell Lithium-Ion Polymer cell / 604975 |
| Energy | Voltage | 11.55V |
| | Amp-hour capacity | 3.291Ah |
| | Watt-hour capacity¹ | 38Wh |
| Temperature | Operating (Charging) | 32° to 113° F (0° to 45° C) |
| | Operating (Discharging) | 14° to 140° F (-10° to 60° C) |
| | Optional Travel Battery Available | No |

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

| | | |
|---|--|---|
| HP 3-cell Long Life Li-Ion (51 Wh)¹ | Weight | 0.229kg +/- 10g (0.505 lb) |
| | Cells/Type | 3cell Lithium-Ion Polymer cell / 566075 |
| Energy | Voltage | 11.58V |
| | Amp-hour capacity | 4.431Ah |
| | Watt-hour capacity¹ | 51.3Wh |
| Temperature | Operating (Charging) | 32° to 113° F (0° to 45° C) |
| | Operating (Discharging) | 14° to 140° F (-10° to 60° C) |
| | Optional Travel Battery Available | No |

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

Technical Specifications

AUDIO

| | |
|-----------------------------------|--|
| HD Stereo Codec | Realtek ALC3315 |
| Audio I/O Ports | Headset : CTIA only and Headphone-out |
| Internal Speaker Amplifier | Cirrus Logic High-Efficiency Boosted Class D Amplifier |
| Multi-streaming Capable | Playback multi-streaming can be enabled in the audio control panel to allow independent audio. Following MSFT Behaviour |
| Sampling | DAC:48kHz ADC:48kHz |
| Wavetable Syntheses | |
| Analog Audio | Support 3.5mm Headset: CTIA only and Headphone-out |
| # of Channels on Line-Out | |
| Internal Speaker | Yes |

FINGERPRINT READER

| | |
|------------------------------------|---|
| Sensor vendor | Main source : Synaptics FS7605 2nd source : ELAN 805W |
| Sensor type | Capacitive |
| DPI resolution | Main source : 363 DPI 2nd source : 508 DPI |
| Scan area | Main source : 104 x 86 pixels 2nd source : 80x80 pixels |
| False Rejection Rate | FRR= \leq 3% |
| False Acceptance Rate | Main source : FAR 1/100K 2nd source : < 0.001% |
| Mobile Voltage Operation | Main source : 3.0V to 3.6V 2nd source : 2.7V~3.6V |
| Operating Temperature | Main source : 0°C~60°C 2nd source : -20°C - +80°C |
| Current Consumption | Main source : 100mA max 2nd source : 35mA peak |
| Image | Main source : 260uA 2nd source : 300uA |
| Low Latency Wait For Finger | Main source : 260uA 2nd source : 300uA |
| Capture Rate | Main source : Image transmitter output frequency 9.6MHz 2nd source : 50 frame/sec |
| ESD Resistance | IEC 61000-4-2 4B (+15KV) |
| Detection Matrix | Main source : 363 dpi / 7.4x6mm sensor area 2nd source : 508 dpi / 4x4mm sensor area |

Technical Specifications

ENVIRONMENTAL DATA

| | | | |
|--|---|---------------------|---------------------|
| Eco-Label Certifications & declarations | <p>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:</p> <ul style="list-style-type: none"> • IT ECO declaration • US ENERGY STAR® • US Federal Energy Management Program (FEMP) • EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country. • TCO • China Energy Conservation Program (CECP) • China State Environmental Protection Administration (SEPA) • Taiwan Green Mark • Korea Eco-label • Japan PC Green label* | | |
| Sustainable Impact Specifications | <ul style="list-style-type: none"> • Product Carbon Footprint (hp.com) • Ocean-bound plastic in Speaker • 65% recycled metal • 60% post-consumer recycled plastic • Low halogen • Outside Box and corrugated cushions are 100% sustainably sourced and recyclable • Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable • Bulk packaging available | | |
| System Configuration | <p>The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.</p> | | |
| Energy Consumption (in accordance with US ENERGY STAR® test method) | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 50Hz |
| Normal Operation (Sort idle) | 5.42 W | 5.64 W | 5.76 W |
| Normal Operation (Long idle) | 1.32 W | 1.32 W | 1.05 W |
| Sleep | 1.32 W | 1.32 W | 1.05 W |
| Off | 0.46 W | 0.47 W | 0.46 W |
| | <p>NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.</p> | | |
| Heat Dissipation* | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 50Hz |
| Normal Operation (Short idle) | 18.5 BTU/hr | 19.3 BTU/hr | 19.7 BTU/hr |

Technical Specifications

| | | | |
|--|--|--|------------|
| Normal Operation (Long idle) | 4.5 BTU/hr | 4.5 BTU/hr | 3.6 BTU/hr |
| Sleep | 4.5 BTU/hr | 4.5 BTU/hr | 3.6 BTU/hr |
| Off | 1.6 BTU/hr | 1.6 BTU/hr | 1.6 BTU/hr |
| | *NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour. | | |
| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | Sound Power (L _{WAd} , bels) | Sound Pressure (L _{pAm} , decibels) | |
| Typically Configured – Idle | 2.7 | 14.0 | |
| Fixed Disk – Random writes | 3.2 | 20.1 | |
| Optical Drive – Sequential reads | 3.7 | 25.3 | |
| Longevity and Upgrading | This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the Spare parts are available throughout the warranty period and or for up to “5” years after the end of production. | | |
| Additional Information | <ul style="list-style-type: none"> • This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. • This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. • This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). • This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net • Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. • This product is 93.8% recycle-able when properly disposed of at end of life. | | |
| Packaging Materials | External: | PAPER/Corrugated | 269 g |
| | | PAPER/Molded Pulp | 108 g |
| | | PAPER/Paper | 3 g |
| | Internal: | PLASTIC/Polyethylene high density – HDPE | 13 g |
| | | The plastic packaging material contains at least 0.0% recycled content. | |
| | | The corrugated paper packaging materials contains at least 59.1% recycled content. | |
| RoHS Compliance | <p>HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.</p> <p>We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.</p> | | |

Technical Specifications

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| | <p>We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.</p> <p>To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.</p> |
| <p>Material Usage</p> | <p>This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):</p> <ul style="list-style-type: none"> • Asbestos • Certain Azo Colorants • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics • Cadmium • Chlorinated Hydrocarbons • Chlorinated Paraffins • Bis(2-Ethylhexyl) phthalate (DEHP) • Benzyl butyl phthalate (BBP) • Dibutyl phthalate (DBP) • Diisobutyl phthalate (DIBP) • Formaldehyde • Halogenated Diphenyl Methanes • Lead carbonates and sulfates • Lead and Lead compounds • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyls (PBBs) • Polybrominated Biphenyl Ethers (PBEBs) • Polybrominated Biphenyl Oxides (PBBOs) • Polychlorinated Biphenyl (PCB) • Polychlorinated Terphenyls (PCT) • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) |
| <p>Packaging Usage</p> | <p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> • Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. • Eliminate the use of ozone-depleting substances (ODS) in packaging materials. • Design packaging materials for ease of disassembly. • Maximize the use of post-consumer recycled content materials in packaging materials. • Use readily recyclable packaging materials such as paper and corrugated materials. • Reduce size and weight of packages to improve transportation fuel efficiency. • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. |

Technical Specifications

| | |
|---|---|
| End-of-life Management and Recycling | <p>HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p> |
| HP, Inc. Corporate Environmental Information | <p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</p> <p>Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html</p> <p>ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</p> |
| footnotes | <ul style="list-style-type: none"> • Percentage of ocean-bound plastic contained in each component varies by product • Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. • External power supplies, WWAN modules, power cords, cables and peripherals excluded. • 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. • Fiber cushions made from 100% recycled wood fiber and organic materials. • Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams |

COUNTRY OF ORIGIN

China

Options and Accessories (Sold separately and availability may vary by country)

DOCKING (Sold Separately)

| | |
|--|--|
| Docking station model #1 | HP Thunderbolt 120W G4 Dock |
| Total number of supported displays (incl. the notebook display) | 4 |
| Max. resolutions supported | Quad 4K @60Hz Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode |
| Dock Connectors | 2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode |
| Technical limitations | Maximum resolution and display support is dependent on the maximum capability of the notebook. Thunderbolt Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz Non-Thunderbolt hosts: The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz. |
| Docking station model #2 | HP Thunderbolt 280W G4 Dock |
| Total number of supported displays (incl. the notebook display) | 4 |
| Max. resolutions supported | Quad 4K @60Hz Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode |
| Dock Connectors | 2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode |
| Technical limitations | Maximum resolution and display support is dependent on the maximum capability of the notebook. Thunderbolt Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz Non-Thunderbolt hosts: The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz. |

Options and Accessories (Sold separately and availability may vary by country)

| | |
|--|---|
| Docking station model #3 | HP USB-C Dock G5 |
| Total number of supported displays (incl. the notebook display) | 3 |
| Max. resolutions supported | Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode) |
| Dock Connectors | 1xHDMI, 2xDP |
| Technical limitations | <p>Maximum resolution and display support is dependent on the maximum capability of the notebook.</p> <p>Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.</p> <p>Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode</p> <p>The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.</p> |
| Docking station model #4 | HP USB-C/A Universal Dock G2 |
| Total number of supported displays (incl. the notebook display) | 3 |
| Max. resolutions supported | Dual 4K @ 60Hz Single 5K @ 60Hz |
| Dock Connectors | 1xHDMI, 2xDP |
| Technical limitations | <p>Maximum resolution and display support is dependent on the maximum capability of the notebook.</p> <p>The best resolution for dual or triple displays is 4K UHD@ 60Hz.</p> <p>For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host.</p> |
| Docking station model #5 | HP USB-C G5 Essential Dock |
| Total number of supported displays (incl. the notebook display) | 3 |
| Max. resolutions supported | <p>For hosts that support DisplayPort 1.4 with Display Stream Compression:</p> <p>3x FHD @ 60 Hz 3x QHD @ 60 Hz 3x 4K @ 60 Hz</p> <p>For hosts that support DisplayPort 1.3/1.4:</p> <p>3x FHD @ 60 Hz 3x QHD @ 60 Hz 2x 4K @ 60 Hz</p> |
| Dock Connectors | 1 x HDMI, 2 x DP |
| Technical limitations | Video resolution depends on the capability of the host machine. This dock provides up to 65W of power delivery to the host machine. |

Options and Accessories (Sold separately and availability may vary by country)

| Type | Description | Part Number |
|----------------|--|-------------|
| Audio | HP Wired USB-A Stereo Headset | 428K6AA |
| | HP Wired 3.5mm Stereo Headset | 428K7AA |
| | HP 365 BT Speaker | 567D3AA#ACJ |
| Video | HP 325 FHD USB-A Webcam | 53X27AA |
| | HP 965 4K USB-A STR Webcam | 695J5AA |
| Docking | HP Thunderbolt 120W G4 Dock | 4J0A2AA |
| | HP Thunderbolt 280W Dock | 4J0G4AA |
| | HP USB-C G5 Dock | 5TW10AA |
| | HP USB-C/A Universal G2 Dock | 5TW13AA |
| Cases | HP Prelude G2 15.6 Backpack | 1E7D6AA |
| | HP Prelude G2 15.6 Top Load | 1E7D7AA |
| | HP Prelude Pro Recycled 15.6 Backpack | 1X644AA |
| | HP Prelude Pro Recycled 15.6 Top Load | 1X645AA |
| | HP Renew 14 Laptop Sleeve | 2E6U9AA |
| | HP Renew Business 14.1 Laptop Bag | 3E5F9AA |
| | HP Renew Business 14.1 Laptop Sleeve | 3E2U7AA |
| | HP Renew Business 15.6 Laptop Bag | 3E5F8AA |
| | HP Renew Business 17.3 Laptop Backpack | 3E2U5AA |
| | HP Renew Business 17.3 Laptop Bag | 3E2U6AA |
| | HP Renew Executive 14.1 Laptop Sleeve | 6B8Y3AA |
| | HP Renew Executive 16 Laptop Backpack | 6B8Y1AA |
| | HP Renew Executive 16 Laptop Bag | 6B8Y2AA |
| | HP Travel 18L 15.6 Iron Gray Laptop Backpack | 6H2D9AA |
| | HP Travel 25L 15.6 Iron Gray Laptop Backpack | 6H2D8AA |
| Hub | HP 4K USB-C Multiport Hub | 6G842AA |
| | HP Universal USB-C Multiport Hub | 50H55AA |
| | HP USB-C Travel Dock G2 | 7PJ38AA |
| | HP USB-C to USB-A Hub | Z6A00AA |
| Adapter | HP USB-C to RJ45 Adapter G2 | 4Z527AA |
| | HP USB 3.0 to Gigabit RJ45 Adapter G2 | 4Z7Z7AA |
| | HP HDMI to VGA Adapter | H4F02AA |
| | HP USB-C to DisplayPort Adapter | N9K78AA |
| | HP USB-C to HDMI 2.0 Adapter | 1WC36AA |
| | HP USB-C to USB 3.0 Adapter | N2Z63AA |

Options and Accessories (Sold separately and availability may vary by country)

| | | |
|---|--|-------------|
| | HP USB-C to VGA Adapter | N9K76AA |
| Keyboard/Combo | HP 125 WD USB Keyboard | 266C9AA |
| | HP 320K WD USB Keyboard | 9SR37AA |
| | HP 355 Compact Multi-Device BT Keyboard | 692S9AA |
| | HP 455 Programmable Wireless Keyboard | 4R177AA |
| | HP 975 USB+BT Dual-Mode Wireless Keyboard | 3Z726AA |
| | HP 155 Wired Mouse and Keyboard Combo | 5B8C0AA#ACJ |
| | HP 225 Antimicrobial Wired Mouse and Keyboard Combo | 286K3AA#AB2 |
| | HP 225 Wired Mouse and Keyboard Combo | 286J4AA |
| | HP 235 Wireless Mouse and Keyboard Combo | 1Y4D0AA |
| | HP 655 Wireless Keyboard and Mouse Combo | 4R009AA |
| | HP Wired Desktop 320MK Mouse and Keyboard | 9SR36AA |
| HP Wireless Rechargeable 950MK Mouse and Keyboard | 3M165AA | |
| Mouse | HP 125 USB-A Wired Mouse | 265A9AA |
| | HP 128 USB Laser Wired Mouse | 265D9AA |
| | HP 155 USB-A Wired Mouse | 5B8B7AA#ACJ |
| | HP 235 Wireless 2.4GHz Slim Wireless Mouse | 4E407AA |
| | HP 320M USB-A Wired Mouse | 9VA80AA |
| | HP 435 Bluetooth 5.0 + Wireless 2.4GHz Multi-Device Wireless Mouse | 3B4Q5AA |
| | HP 715 Rechargeable Multi-Device Bluetooth 5.0 + Wireless 2.4GHz Bluetooth Mouse | 6E6F0AA |
| | HP 925 Ergonomic Vertical Bluetooth 5.0 + Wireless 2.4GHz Wireless Mouse | 6H1A5AA |
| | HP Creator USB-A+Bluetooth 935 Wireless Mouse Black | 1D0K8AA |
| | HP USB Premium Wireless Mouse | 1JR31AA |
| | HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black | 1D0K2AA |
| HP USB-A+Bluetooth Travel Bluetooth Mouse | 6SP30AA | |
| Power | HP 65W GaN USB-C Laptop Charger | 600Q7AA |
| | HP 65W USB-C Laptop Charger | 671R3AA |
| | HP 65W USB-C LC AC Power Adapter | 1P3K6AA |
| Commodity | HP USB DVD-Writer EXT ODD | F2B56AA |
| | HP Nano Keyed Cable Lock | 1AJ39AA |
| | HP Nano Master Keyed Cable Lock | 1AJ40AA |
| | HP SureKey Standard/Nano/Wedge Cable Lock | 6UW42AA |
| | HP Combination Nano Cable Lock | 63B28AA |
| | HP Essential Combination Nano Cable Lock | 63B31AA |

Change Log

| Date of change: | Version History: | | Description of change: |
|------------------------|-------------------------|---------|---|
| May 30, 2023 | V1 to V2 | Added | Environmental Data |
| June 5, 2023 | V2 to V3 | Updated | Ports and Slots, Storage and Drives section |
| June 14, 2023 | V3 to V4 | Added | Processors |
| June 28, 2023 | V4 to V5 | Updated | HDMI Port and Product Weight |
| June 30, 2023 | V5 to V6 | Updated | Environmental Data |
| August 1, 2023 | V6 to V7 | Updated | Environmental Data |
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